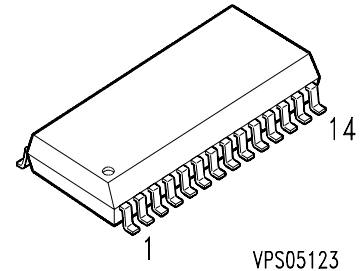
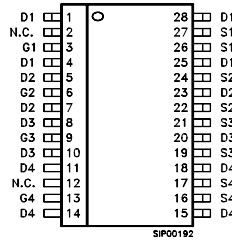


#### SIPMOS<sup>®</sup> Power Transistor

- Quad-channel
- Enhancement mode
- Avalanche-rated
- $dv/dt$  rated



VPS05123

Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package	Ordering Code
BUZ 103S-4	55 V	5.3 A	0.045 $\Omega$	P-DSO-28	C67078-S. . . . -A..

#### Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current <i>one channel active</i> $T_A = 25\text{ }^\circ\text{C}$	$I_D$	5.3	A
Pulsed drain current <i>one channel active</i> $T_A = 25\text{ }^\circ\text{C}$	$I_{Dpuls}$	21.2	A
Avalanche energy, single pulse $I_D = 5.3\text{ A}$ , $V_{DD} = 25\text{ V}$ , $R_{GS} = 25\text{ }\Omega$ $L = 9.97\text{ mH}$ , $T_j = 25\text{ }^\circ\text{C}$	$E_{AS}$	140	mJ
Reverse diode $dv/dt$ $I_S = 5.3\text{ A}$ , $V_{DS} = 40\text{ V}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ $T_{jmax} = 175\text{ }^\circ\text{C}$	$dv/dt$	6	kV/ $\mu\text{s}$
Gate source voltage	$V_{GS}$	$\pm 20$	V
Power dissipation <i>,one channel active</i> $T_A = 25\text{ }^\circ\text{C}$	$P_{tot}$	2.4	W
Operating temperature	$T_j$	-55 ... + 175	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 ... + 175	$^\circ\text{C}$
IEC climatic category, DIN IEC 68-1		55 / 175 / 56	

### Thermal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Thermal resistance, junction - soldering point <sup>1)</sup>	$R_{thJS}$	-	tbd	-	K/W
Thermal resistance, junction - ambient <sup>2)</sup>	$R_{thJA}$	-	62.5	-	

1) Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer,70µm thick) copper area for Drain connection. PCB is vertical without blown air.

2) one channel active

### Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

#### Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}, T_j = 25 \text{ }^\circ\text{C}$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}, I_D = 50 \text{ }\mu\text{A}$	$V_{GS(th)}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 55 \text{ V}, V_{GS} = 0 \text{ V}, T_j = -40 \text{ }^\circ\text{C}$ $V_{DS} = 55 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$ $V_{DS} = 55 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$	$I_{DSS}$	-	-	0.1 1 100	$\mu\text{A}$
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	$I_{GSS}$	-	10	100	
Drain-Source on-resistance $V_{GS} = 10 \text{ V}, I_D = 5.3 \text{ A}$	$R_{DS(on)}$	-	0.035	0.045	

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Dynamic Characteristics</b>					
Transconductance $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$ , $I_D = 5.3 \text{ A}$	$g_{fs}$	4	-	-	S
Input capacitance $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{iss}$	-	720	900	pF
Output capacitance $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{oss}$	-	230	300	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{rss}$	-	125	160	
Turn-on delay time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 5.3 \text{ A}$ $R_G = 13 \Omega$	$t_{d(on)}$	-	17	25	ns
Rise time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 5.3 \text{ A}$ $R_G = 13 \Omega$	$t_r$	-	17	25	
Turn-off delay time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 5.3 \text{ A}$ $R_G = 13 \Omega$	$t_{d(off)}$	-	40	60	
Fall time $V_{DD} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 5.3 \text{ A}$ $R_G = 13 \Omega$	$t_f$	-	25	40	
Gate charge at threshold $V_{DD} = 40 \text{ V}$ , $I_D \geq 0.1 \text{ A}$ , $V_{GS} = 0 \text{ to } 1 \text{ V}$	$Q_{g(th)}$	-	1.3	2	nC
Gate charge at 7.0 V $V_{DD} = 40 \text{ V}$ , $I_D = 5.3 \text{ A}$ , $V_{GS} = 0 \text{ to } 7 \text{ V}$	$Q_{g(7)}$	-	20	30	
Gate charge total $V_{DD} = 40 \text{ V}$ , $I_D = 5.3 \text{ A}$ , $V_{GS} = 0 \text{ to } 10 \text{ V}$	$Q_{g(total)}$	-	25	40	
Gate plateau voltage $V_{DD} = 40 \text{ V}$ , $I_D = 5.3 \text{ A}$	$V_{(plateau)}$	-	5.03	-	V

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

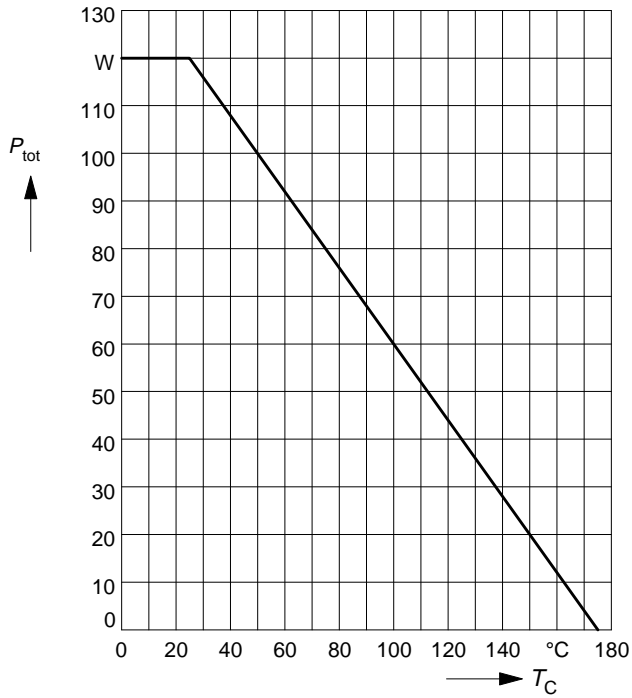
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Reverse Diode**

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	$I_S$	-	-	5.3	A
Inverse diode direct current, pulsed $T_A = 25^\circ\text{C}$	$I_{SM}$	-	-	21.2	
Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = 10.6\text{ A}$	$V_{SD}$	-	0.95	1.6	V
Reverse recovery time $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	$t_{rr}$	-	60	90	ns
Reverse recovery charge $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	$Q_{rr}$	-	90	140	nC

### Power dissipation

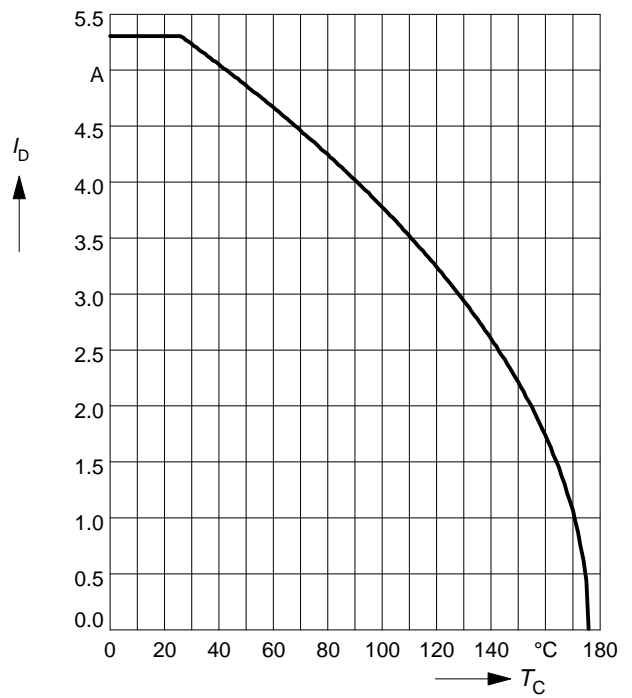
$$P_{\text{tot}} = f(T_C)$$



### Drain current

$$I_D = f(T_C)$$

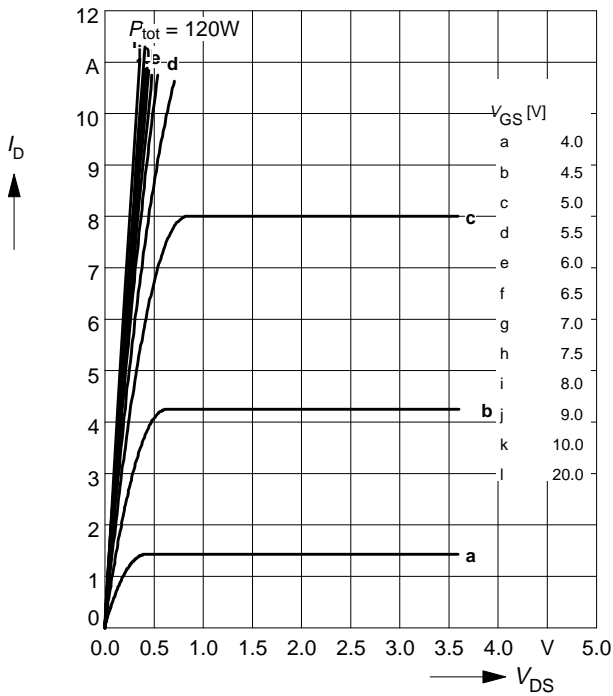
parameter:  $V_{GS} \geq 10 \text{ V}$



### Typ. output characteristics

$$I_D = f(V_{DS})$$

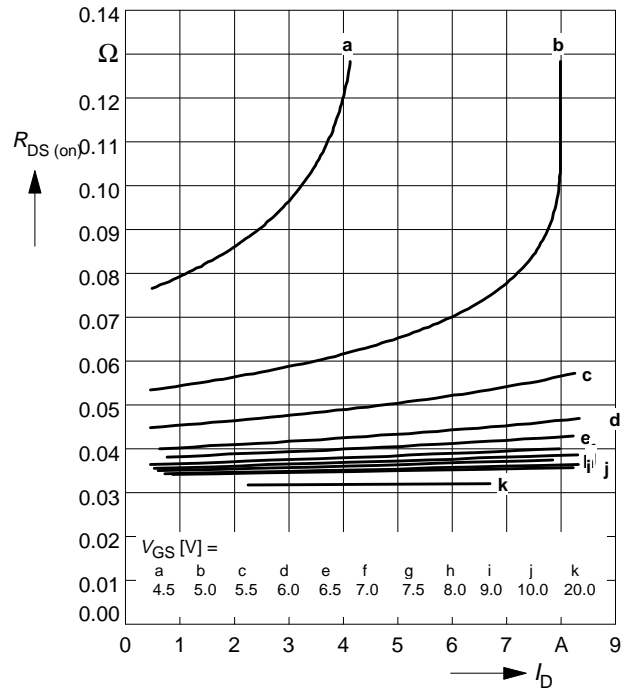
parameter:  $t_p = 80 \mu s$



### Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

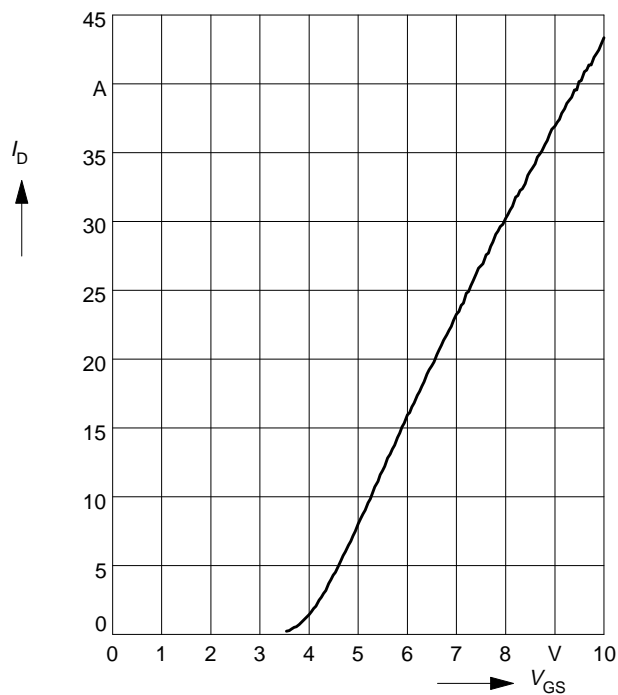
parameter:  $t_p = 80 \mu s, T_j = 25 \text{ }^\circ\text{C}$



### Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$

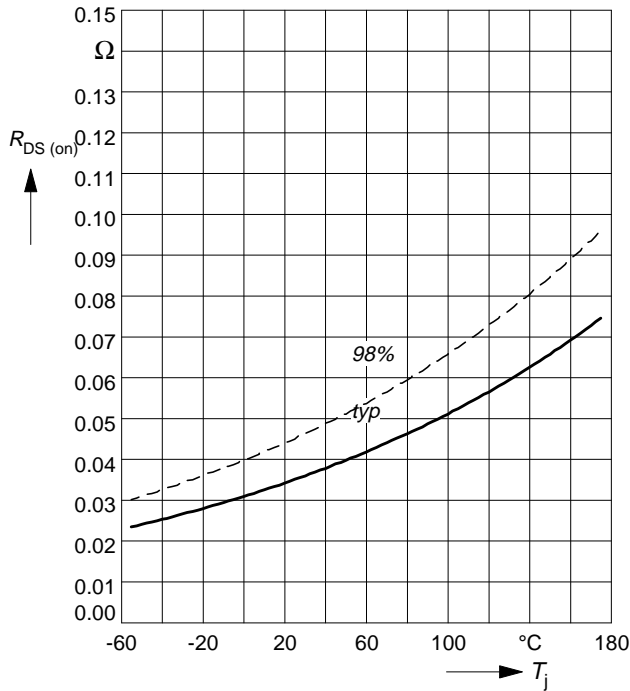
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



### Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

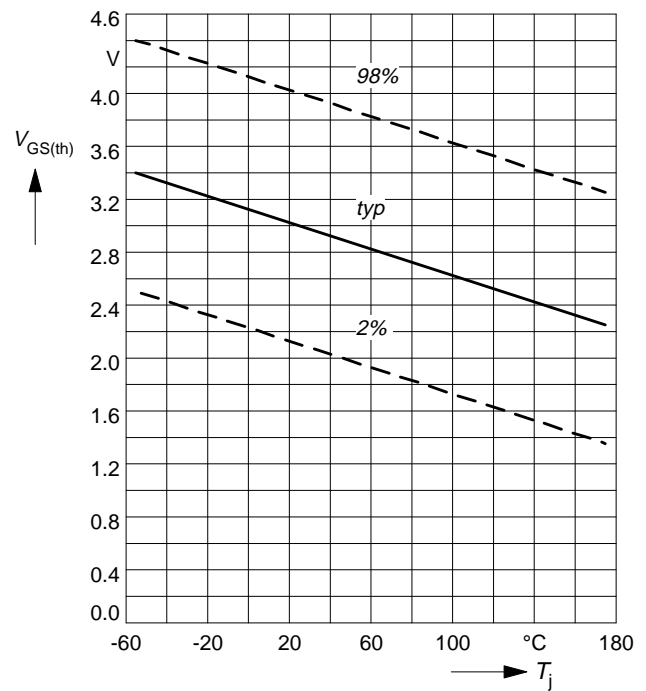
parameter:  $I_D = 5.3 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$



### Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

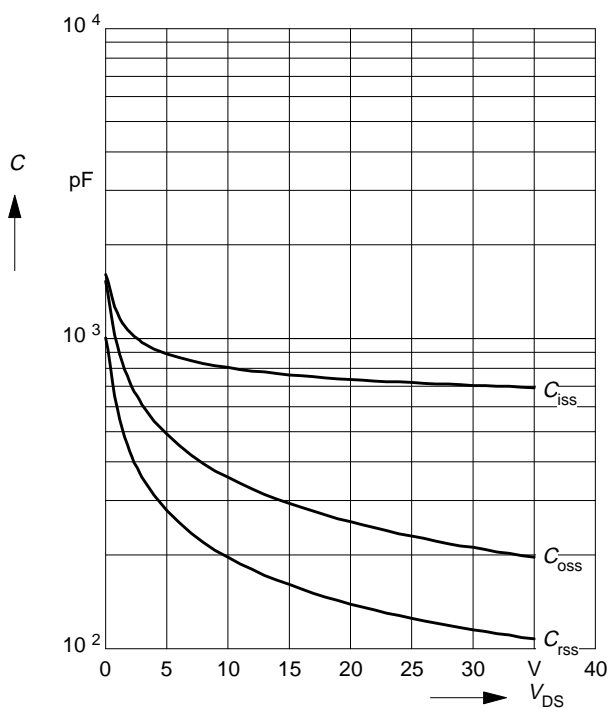
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 50 \mu\text{A}$



### Typ. capacitances

$$C = f(V_{DS})$$

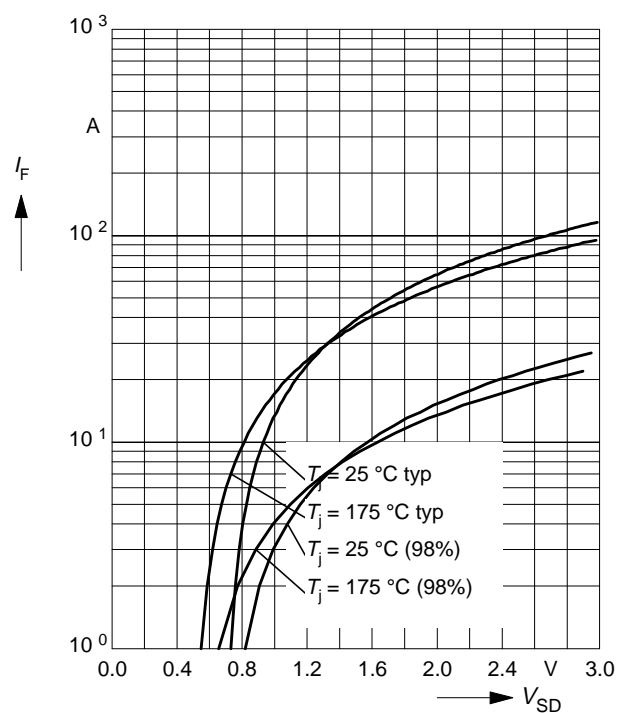
parameter:  $V_{GS} = 0\text{V}$ ,  $f = 1\text{MHz}$



### Forward characteristics of reverse diode

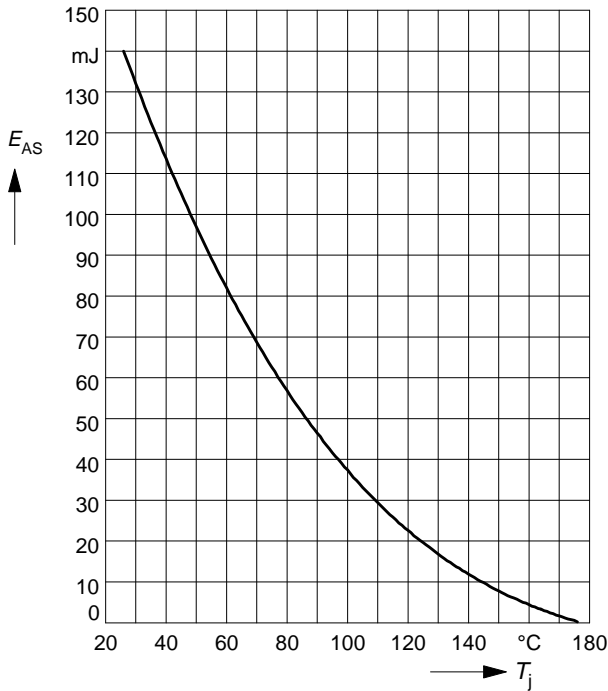
$$I_F = f(V_{SD})$$

parameter:  $T_j$ ,  $t_p = 80 \mu\text{s}$



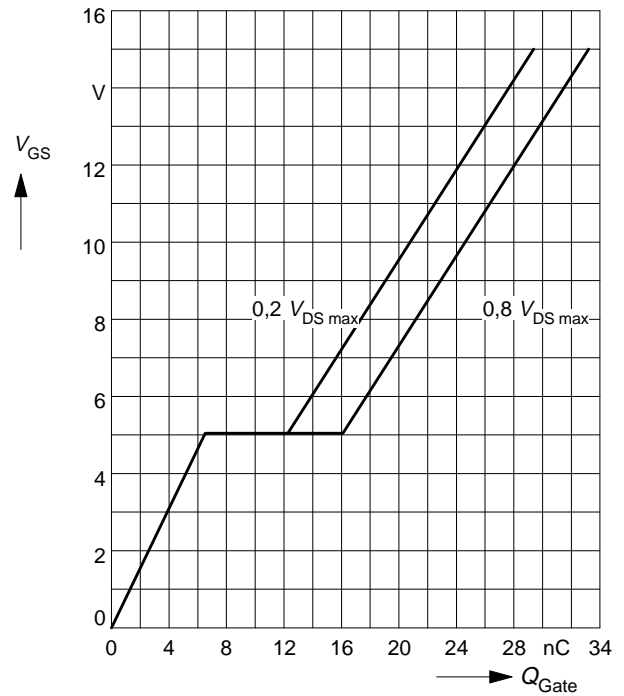
### Avalanche energy $E_{AS} = f(T_j)$

parameter:  $I_D = 5.3 \text{ A}$ ,  $V_{DD} = 25 \text{ V}$   
 $R_{GS} = 25 \text{ } \Omega$ ,  $L = 9.97 \text{ mH}$



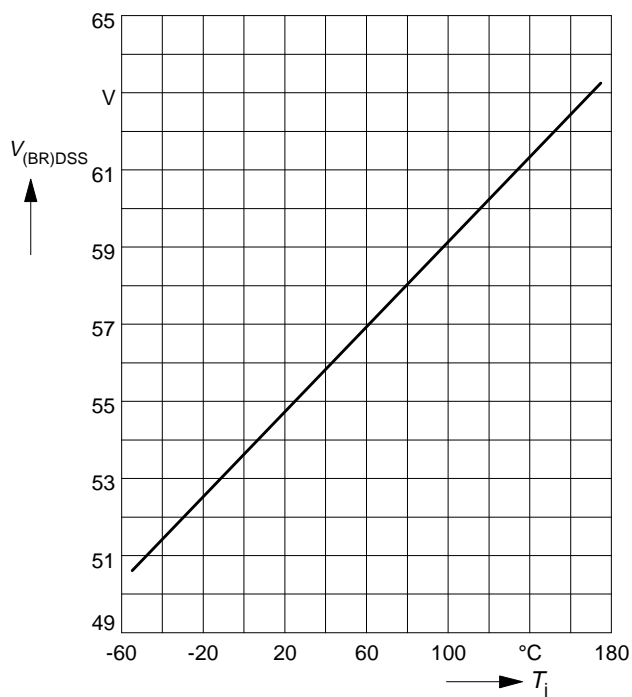
### Typ. gate charge $V_{GS} = f(Q_{Gate})$

parameter:  $I_{D \text{ puls}} = 5 \text{ A}$



### Drain-source breakdown voltage $V_{(BR)DSS} = f(T_j)$

$V_{(BR)DSS} = f(T_j)$





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